



2016年创新材料科学与技术国际学术会议

尊敬的_____先生/女士，您好！

2016年创新材料科学与技术国际学术会议将于2016年08月在深圳召开。

会议通知

The aim of IMST 2016 is to provide a platform for researchers, engineers, and academicians, as well as industrial professionals, to showcase their research results in the fields of Innovative Material Science and Technology. It provides opportunities for the delegates to exchange new ideas and application experiences, to establish business or research relations and to find global partners for future collaboration. We warmly welcome the prospective authors who are interested in the fields to submit their up-to-date and original research papers to the IMST 2016 Organizing Committee!

2016年创新材料科学与技术国际学术会议将在8月19-21日在中国深圳召开。本次会议邀请了土耳其 Mehmet Akif Ersoy University的Prof. Nurettin Korozlu，特里布文大学教授 Prof. Bhadra Prasad Pokharel，马来西亚彭亨大学副教授Dr. Md. Maksudur Rahman Khan，新加坡南洋理工大学副教授 Dr. Erjia Liu等专家 出席会议并做大会报告。届时将有美国，新加坡，香港，中国，台湾，马来西亚，澳大利亚，波兰，澳大利亚沙等国家的教授，学者，科研人员参会并做报告。本次会议所收录的文章将提交到EI系列期刊出版，并提交EI，CPCI，Scopus等检索机构审核检索。优秀文章增加内容后可以推荐到Materials Research Innovations期刊发表，EI检索（JA。大会旨在促进材料科学与技术等领域的研究与交流。欢迎广大学者踊跃投稿和参会。

会议主题：

(1)材料科学与工程

金属，聚合物，复合材料，半导体与功能材料，有机和无机材料，陶瓷和玻璃，纳米材料，生物材料，核燃料材料，传感器和曲面，磁性材料，超导材料，结构材料，自旋电子学材料，和多孔催化材料，金属和氧化物超晶格，能源材料，智能材料

(2)材料性能及材料加工

延展性和抗裂，断裂力学，机械性能，电性能和磁性能，侵蚀，腐蚀和耐磨性，毒性，金相，粉末冶金与热处理，表面处理，焊接，铸造和烧结，加工，涂层

(3)材料科学与技术创新

发现或发展新材料，千兆（间位）技术，创新材料，推动生物应用，新型离子交换材料，材料研究，分析与建模方法论，在工程任务和科研计算机援助，快速原型，材料与工程数据库，计算材料学

会议名称：2016年创新材料科学与技术国际学术会议

会议时间：2016年8月19-21日

会议地点：广东深圳长安大酒店

会议日程

August 19, 2016 Conference Registration 大会注册

August 20, 2016

09:00-09:15 Open Ceremony 大会开幕
09:15-10:00 Keynote Speech 主题演讲
10:00-10:15 Coffee Break 茶歇
10:15-12:00 Oral Session 1 口头展示
12:00-13:00 Lunch 午饭
14:00-15:30 Oral Session 2 口头展示
15:30-15:40 Coffee Break 茶歇
15:40-17:00 Oral Session 3 口头展示

August 21, 2016

09:30-11:00 Oral Session 4 口头展示
11:00-11:30 The Conference Summary 大会闭幕
11:30 Lunch and Free Time 午饭和自由时间

*日程如有变动，请以会议官网发布为准。

The official Conference Schedule should rely on the issue by AEST2016 Organization Committee if there is any change about the information.

会议嘉宾

Prof. Nurettin Korozlu , Department of Nanotechnology and Nanoscience, Mehmet AkifErsoy University, Burdur, Turkey
Keynote Speech Title: Genetic-Algorithm Optimization of Thermoelectric Materials β -X₈Sb₇(X=Zn, Cd) Calculated within DFT

Prof. Bhadra Prasad Pokharel ,Materials Science and Engineering Program, Pulchowk Campus, Institute of Engineering, Tribhuvan University, Lalitpur Kathmandu, Nepal
Keynote Speech Title: Chemically Activated Nano-Porous Carbon From Lapsi Seed For Multifunctional Material Applications

Dr. Md. Maksudur Rahman Khan , Associate Professor, Faculty of Chemical and Natural Resources Engineering, Universiti Malaysia Pahang, Malaysia
Keynote Speech Title: Visible Light Responsive Nanostructured Composite Materials for CO₂ Conversion to Fuel

Dr. Erjia Liu , Associate Professor, School of Mechanical & Aerospace Engineering, Nanyang Technological University, Singapore
Keynote Speech Title: Anti-adhesion, Low Friction Coatings on Micromolds for Quality Replication of Polymer Microfluidic Devices

会议门票

Registration Fees

For the publication on conference proceedings:

- Regular Registration: RMB3000 or USD500
- Student Registration: RMB2800 or USD455

- Additional papers: RMB2600 or USD425
- Extra Page (More than 8 pages): RMB300 or USD50
- Attendees without Papers: RMB1600 or USD250

For the publication on journal of Materials Research Innovations:

- Regular Registration: RMB6000 or USD1000

*The total registration fee for publication on journal of Materials Research Innovations is RMB6000/USD1000. It includes the publication fee and the registration fee for attending the conference proceedings.

*作者注册为期刊发表论文的注册费为6000人民币/1000美元，此注册费包含了一篇文章的期刊出版费用以及一位论文作者的参会费用，无需再另外为会议注册。

Author's registration Fee includes

*Full Paper being published on EI Serial Journal and Indexing Services

- * Access to the proceeding online
- * Participation in the Technical Program
- * 10-20 minutes presentation
- * Conference Kits
- * Lunch
- * Coffee Breaks

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Details of the Registration Fees

1. Each paid registration covers only one paper; you can pay Extra Paper Charges (Additional papers: RMB2600 or USD425) for one more paper from the same first author who already has a paid registration.
2. One regular registration with one or more additional papers has only one proceeding. One regular registration can cover a paper within eight (8) pages, including all figures, tables, and references.
3. If the length of the paper exceeds eight (8) Pages, the cost of Each Extra Page (begin at Page 9) is RMB300 or USD50.
4. Registration fees include conference proceedings, lunches, gifts and attending all technical sessions.
5. At least one author for each accepted final paper must pre-register.
6. The registration fee does not include:
 - Accommodation
 - Visa application fee
 - Transportation fee
7. Completed registrations will be acknowledged by the Organizing Committee within seven (7) days after receiving your payment.
8. If you cannot attend the conference due to some reasons, we will mail the proceedings and invoice to you.

